PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q77166

YAMAGUCHI, Miho, et al.

Divisional of Appln. No.: 10/181/020

Group Art Unit: Not Yet Assigned

Confirmation No.: Not Yet Assigned

Examiner: Not Yet Assigned

Filed: August 27, 2003

For:

POROUS ADHESIVE SHEET, SEMICONDUCTOR WAFER WITH POROUS

ADHESIVE SHEET, AND METHOD OF MANUFACTURE THEREOF

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR §§ 1.97 and 1.98

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure under 37 CFR §1.56, Applicant hereby notifies the U.S. Patent and Trademark Office of the documents which are listed on the attached PTO/SB/08 A & B (modified) form which are all the references of record in parent application No. 10/181,020as cited in the International Search Report. Applicant is not submitting duplicate copies of these references but requests that they be listed on the face of any patent granted on the above application. (See 37 CFR §1.98(d)). Copies of any cited copending applications, if not previously submitted, are being submitted herewith.

A translation of the International Preliminary Examination Report is enclosed.

The submission of the listed documents is not intended as an admission that any such document constitutes prior art against the claims of the present application. Applicant does not

INFORMATION DISCLOSURE STATEMENT DIVISIONAL OF APPLN. NO. 10/ 181,020

waive any right to take any action that would be appropriate to antedate or otherwise remove any listed document as a competent reference against the claims of the present application.

Respectfully submitted,

Registration No. 24,835

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Date: August 27, 2003

Complete if Known Substitute for Form 1449 A & B/PTO Application Number Divisional of 10/181,020 INFORMATION DISCLOSURE Confirmation Number Not Yet Assigned Filing Date August 27, 2003 STATEMENT BY APPLICANT First Named Inventor YAMAGUCHI, Miho Art Unit Not Yet Assigned (use as many sheets as necessary) Examiner Name Not Yet Assigned

			U.S. P	ATENT DOCUM	IENTS
E	Cita	Document N	lumber	Dublication Data	
Examiner Initials*	Cite No.1	Number	Kind Code ² (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
		US			
		US			

Attorney Docket Number

Q77166

Sheet

			F	OREIGN PA	TENT DOCUME	NTS	
Examiner	Cite	Foreign Patent Document			Publication Date	Name of Patentee or	m 6
Initials*	No.1	Country Code ³	Number ⁴	Kind Code ⁵ (if known)	MM-DD-YYYY	Applicant of Cited Document	Translation ⁶
		JP	63-136527	Α	6/8/1988		
		JP	62-191847	U	12/5/1987		
		JP	61-90835	U	6/12/1987		
		JР	3-1945	U	1/10/1991		
		JP	4-130426	U	11/30/1992		
		JP	61-259406	A	11/17/1986		
		JР	10-284156	Α	10/23/1998		
		JP	8-306415	A	11/22/1996		
		JP	6-231818	Α	8/19/1994		
		JP	4-363811	A	12/16/1992		
		JP	6419607	Α	1/23/1989		
		JР	62-51111	Α	3/5/1987		
		EP	560072	A2	9/15/1993		
		JP	2000-17240	A	1/18/2000		

		NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation ⁶
		Tokkyochou "Shuuchi Kanyou Gijutsushu (Secchaku)" 6/15/1984 p. 188, p. 189, pg. 235	

Examiner Signature	Date Considered	

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Applicant's unique citation designation number (optional). ²See Kind Codes of USPTO Patent Documents at www.uspto.gov, MPEP 901.04 or in the comment box of this document. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to indicate here if English language Translation is attached.

Translation

PATENT COOPERATION TREATY

PCT

INTERNATIONAL PRELIMINARY EXAMINATION REPORT

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference 09372		NotificationofTransmittalofInternational Preliminary amination Report (Form PCT/IPEA/416)
International application No. PCT/JP00/05553	International filing date (day/month) 18 August 2000 (18.08.0	
International Patent Classification (IPC) or n C09J 7/02, H01L 23/12, H01R 1		
Applicant	NITTO DENKO CORPORA	TION
This international preliminary examinand is transmitted to the applicant ac This REPORT consists of a total of	cording to Article 36.	nis International Preliminary Examining Authority
amended and are the basis for		description, claims and/or drawings which have been rectifications made before this Authority (see Rule PCT).
These annexes consist of a tot	al of sheets.	
IV Lack of unity of inverse volume and explanations and explanations and explanations and explanations and explanations are considered to the volume and the	f opinion with regard to novelty, invention under Article 35(2) with regard to notions supporting such statement	entive step and industrial applicability velty, inventive step or industrial applicability;
Date of submission of the demand	Date of com	pletion of this report
17 May 2001 (17.05.6	01)	12 February 2002 (12.02.2002)
Name and mailing address of the IPEA/JP	Authorized	officer
Facsimile No.	Telephone N	Io.

Form PCT/IPEA/409 (cover sheet) (July 1998)

International application No.

INTERNATIONAL PRELIMINARY EXAMINATION REPORT

PCT/JP00/05553

Basis	of the re	eport ,	_
With	regard to	o the elements of the international application:*	
	the inte	ernational application as originally filed	
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in thi	is report	heets which have been furnished to the receiving Office in response to an invitation under Article 14 are referred t as "originally filed" and are not annexed to this report since they do not contain amendments (Rule 70.1	o 6
	•	nt sheet containing such amendments must be referred to under item I and annexed to this report.	
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INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International application No. PCT/JP 00/05553

	Statement	
	Novelty (N)	Claims 1, 2, 4-7, 9-13 YES
		Claims
	Inventive step (IS)	Claims 1, 2, 4-7, 9-13 YES
		· Claims NO
	Industrial applicability ((IA) Claims 1, 2, 4-7, 9-13 YES
		Claims
_	Citations and explanatio	ons .
	Document 1:	Japanese Patent Office, "Shuuchi kanyou
		gijutsushu (Setchaku)" 15 June 1984, p. 188,
		p. 235
	Document 2:	JP, 63-136527, A (NEC Corp.), 8 June 1988;
		claims (Family: none)
	Document 3:	JP, 62-191847, U (Seiko Epson Corp.), 5
		December 1987; claims (Family: none)
	Document 5:	JP, 61-90835, U (NEC Corp.), 12 June 1986;
	•	claims (Family: none)
	Document 6:	JP, 3-1945, U (NEC Corp.), 10 January 1991;
		claims (Family: none)
	Document 7:	JP, 4-130426, U (Nitto Electric Co., Ltd,),
		30 November 1992; claims (Family: none)
	Document 8:	JP, 61-259406, A (Nitto Electric Co., Ltd.),
		17 November 1986; claims (Family: none)
	Document 9:	JP, 10-284156, A (Nitto Electric Co., Ltd.),
		23 October 1998; claims and paragraph [0048]
		(Family: none)
	Document 10:	JP, 8-306415, A (Nitto Electric Co., Ltd.),
		22 November 1996; claims and Fig. 3 (Family:
		none)
	Document 11:	JP, 6-231818, A (Nitto Electric Co., Ltd.),

19 August 1994; claims (Family: none)

Document 12: JP, 4-363811, A (Nitto Electric Co., Ltd.),

PCT/JP 00/05553

16 December 1992; claims (Family: none)

Document 13: JP, 64-19607, A (Nitto Electric Co., Ltd.), 23 January 1989; claims (Family: none)

Document 14: JP, 62-51111, A (Nitto Electric Co., Ltd.), 5 March 1987; claims (Family: none),

Document 15: EP, 560072, A2 (Nitto Denko Corp.) 15 September 1993; Claims & JP, 5-258789 & JP, 5-258790 & US, 5438223, A

The inventions set forth in Claims 1, 2, 4-6, 12 and 13 are novel and involve an inventive step.

None of Documents 1-3 or 5-15, cited in the international search report, discloses a porous adhesive sheet which is an adhesive sheet having a plurality of through holes running substantially parallel to one another in the direction of the thickness of the organic film, with layers of a certain organic material being formed around the aforementioned through holes, the fact that said porous adhesive sheet has a layer of a certain readily adhesive material, a process for producing said porous adhesive sheet, semiconductor wafers fitted with a porous adhesive sheet formed to a certain shape, or a process for producing semiconductor wafers fitted with a porous adhesive sheet using said porous adhesive sheet; and these inventions are not obvious to a person skilled in the art.

INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International application No.

PCT/JP00/05553

Application No. Patent No.	Publication (day/month		Filing date (day/month/year)	1	Priority date (validate) (day/month/ye	
JP 2000-17240 A	18 January 2000		02 July 1998 (02.07.	1998)		
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